



EC Declaration of Conformity (DoC)

We

Texas Instruments Incorporated
 12500 TI Boulevard
 Dallas, Texas 75243 USA

Declare that the DoC is issued under our sole responsibility and belongs to the following product(s):

Marketing Name:	SimpleLink™ Wi-Fi® CC3220MOD Wireless Microcontroller Module
Equipment Name:	2.4GHz Wi-Fi® Module
Model Number:	CC3220MODSF12MOB
SW Version:	2.2.0.5
HW Version:	Rev A

The object of the declaration described above is in conformity with the relevant Union harmonization legislation:

Radio Equipment Directive 2014/53/EU
 RoHS2 Directive 2011/65/EU

Accessories information:

Antennas

Antenna List					
	Brand	Antenna Type	Model	2.4GHz gain	
1	FoxCon	PCB	T77H533	2.5dBi	
2	Ethertronics	Dipole	1000423	-0.6dBi	
3	LSR	Rubber Whip / Dipole	001-0012	2dBi	
4			080-0013	2dBi	
5			080-0014	2dBi	
6		PIFA	001-0016	2.5dBi	
7			001-0021	2.5dBi	
8		Laird	PCB	CAF94504	2dBi
9	CAF94505			2dBi	
10	ACX	Multilayer Chip	AT3216-BR2R7HAA	0.5dBi	
11			AT312-T2R4PAA	1.5dBi	
12	TDK	Multilayer Ceramic Chip Antenna	ANT016008LCD2442MA1	1.6dBi	
13			ANT016008LCD2442MA2	2.5dBi	
14	Mitsubishi Material	Chip Antenna	AM03DP-ST01	1.6dBi	
15		Antenna Unit	UB18CP-100ST01	-1.0dBi	
16	Taiyo Yuden	Chip Antenna / Helical Monopole	AF216M245001	1.5dBi	
17			Chip Antenna / Monopole Type	AH212M245001	1.3dBi
18				AH316M245001	1.9dBi
19	Antenna Technology	Dipole	AA2402SPU	2.0dBi	
20			AA2402RSPU	2.0dBi	
21			AA2402A-UFLLP	2.0dBi	

22			AA2402AU-UFLLP	2.0dBi
23	Staf	Mono-pole	1019-016	2.14dBi
24			1019-017	2.14dBi
25			1019-018	2.14dBi
26			1019-019	2.14dBi
27			Map Electronics	Rubber Whip
28	MEIWX-2411RSXX-2400	2.0dBi		
29	MEIWX-282XSAXX-2400	2.0dBi		
30	MEIWX-282XRSXX-2400	2.0dBi		
31	MEIWF-HP01RS2X-2400	2.0dBi		
32	Yageo	Chip	ANT3216A063R2400A	1.69dBi
33	Mag Layers Scientific	Chip	LTA-3216-2G4S3-A1	1dBi
34			LTA-3216-2G4S3-A3	2dBi
35	Advantech	Rubber Whip / Dipole	AN2450-5706RS	2.38dBi

The following harmonized standards and technical specifications have been applied:

EN 301489-1 V2.1.1	ElectroMagnetic Compatibility (EMC) standard for radio equipment and services; Part 1: Common technical requirements; Harmonised Standard covering the essential requirements of article 3.1(b) of the Directive 2014/53/EU and the essential requirements of article 6 of the Directive 2014/30/EU;
EN 301489-17 V3.1.1	ElectroMagnetic Compatibility (EMC) standard for radio equipment and services; Part 17: Specific conditions for Broadband Data Transmission Systems; Harmonised Standard covering the essential requirements of article 3.1(b) of Directive 2014/53/EU
EN 300328 v2.1.1	Wideband transmission systems; Data transmission equipment operating in the 2,4 GHz ISM band and using wide band modulation techniques; Harmonised Standard covering the essential requirements of article 3.2 of Directive 2014/53/EU
EN 62311:2008	Assessment of electronic and electrical equipment related to human exposure restrictions for electromagnetic fields (0 Hz - 300 GHz)
EN 60950-1:2006+A11:2009+A1:2010+A12:2011+A2:2013	Information technology equipment – Safety-Part 1: General requirements
EN 50581:2012	Technical documentation for the assessment of electrical and electronic products with respect to the restrictions of hazardous substances



Notified Body:

Notified Body:	PHOENIX TESTLAB GMBH
Notified Body Number	700
Reference number of the certificate of notified body	17-211764

Technical Compliance File Held by:

Texas Instruments Incorporated
12500 TI Boulevard
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Signed for and on behalf of Texas Instruments Incorporated

Name:	Mattias Lange, General Manager
Address:	12500 TI Boulevard., Dallas Texas, 75243 USA

DALLAS, TX

Place of issue

6/30/17

Date of issue



Signature of Authorized Person

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